

2A, 50V - 1400V Standard Bridge Rectifier

FEATURES

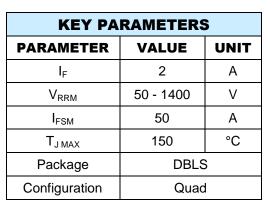
- AEC-Q101 qualified available
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

| ΔD | DI | ICA | TI | 0 | NS. |
|------------|--------------|-----|----|---|------|
| AF | \mathbf{r} | | | u | 14-2 |

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

MECHANICAL DATA

- Case: DBLS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.360g (approximately)



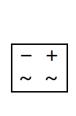


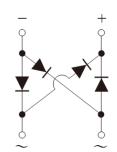






DBLS





| ABSOLUTE MAXIM | | | | | | | | | | I | |
|---|------------------|--------------|--------------|--------------|------------------|------|--------------|--------------|--------------|--------------|-------------|
| PARAMETER | SYMBOL | | DBLS | | | | | | | | UNIT |
| | | 201G | 202G | 203G | 204G | 205G | 206G | 207G | 208G | 209G | |
| Marking code on the device | | DBLS 201G | DBLS 202G | DBLS 203G | DBLS 204G | | DBLS 206G | DBLS 207G | DBLS 208G | DBLS 209G | |
| Repetitive peak reverse voltage | V_{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | 1200 | 1400 | V |
| Reverse voltage, total rms value | $V_{R(RMS)}$ | 35 | 70 | 140 | 280 | 420 | 560 | 700 | 840 | 980 | V |
| Forward current | I_{F} | 2 | | | | Α | | | | | |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I _{FSM} | 50 | | | | | А | | | | |
| Rating for fusing (t<8.3ms) | l ² t | 10.3 | | | A ² s | | | | | | |
| Junction temperature | TJ | - 55 to +150 | | | °C | | | | | | |
| Storage temperature | T _{STG} | - 55 to +150 | | | °C | | | | | | |

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| THERMAL PERFORMANCE | | | | | | |
|--|-----------------|-----|------|--|--|--|
| PARAMETER | SYMBOL | TYP | UNIT | | | |
| Junction-to-lead thermal resistance | $R_{\Theta JL}$ | 15 | °C/W | | | |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 40 | °C/W | | | |

| PARAMETER | | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
|---|--|--|------------------|-----|------|------|
| Forward voltage per diode ⁽¹⁾ | DBLS201G DBLS202G DBLS203G DBLS204G DBLS205G DBLS206G DBLS207G | I _F = 2A, T _J = 25°C | V _F | - | 1.15 | V |
| | DBLS208G DBLS209G | | | - | 1.30 | V |
| Reverse current @ rated V _R per diode ⁽²⁾ | | T _J = 25°C | | - | 2 | μΑ |
| | | T _J = 125°C | · I _R | - | 500 | μA |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | | | | |
|---------------------------------|---------|---------------------|--|--|--|
| ORDERING CODE ⁽¹⁾⁽²⁾ | PACKAGE | PACKING | | | |
| DBLS2xG | DBLS | 1,500 / Tape & Reel | | | |
| DBLS2xGH | DBLS | 1,500 / Tape & Reel | | | |

Notes:

- 1. "x" defines voltage from 50V(DBLS201G) to 1400V(DBLS209G)
- 2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

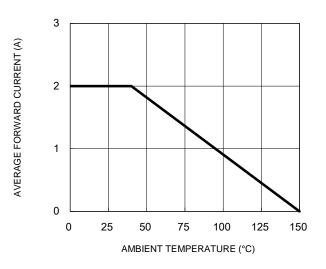


Fig.3 Typical Reverse Characteristics

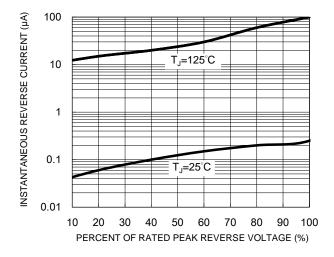


Fig.2 Typical Junction Capacitance

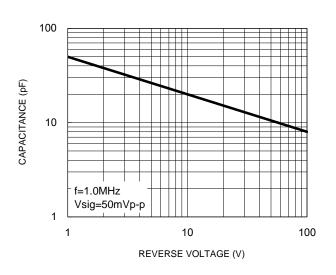


Fig.4 Typical Forward Characteristics

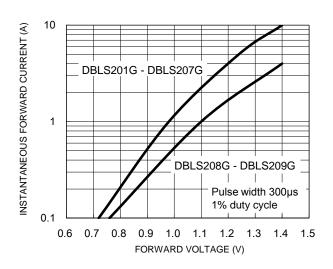
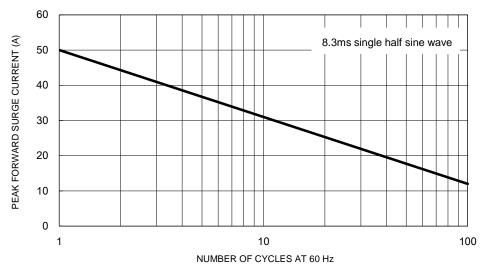


Fig.5 Maximum Non-Repetitive Forward Surge Current

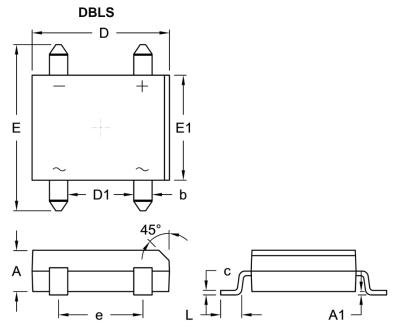


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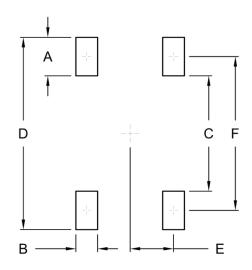


PACKAGE OUTLINE DIMENSIONS



| DIM. | Unit | (mm) | Unit (inch) | | |
|--------|-------|-------|-------------|-------|--|
| Dilvi. | Min. | Max. | Min. | Max. | |
| А | 2.40 | 2.60 | 0.094 | 0.102 | |
| A1 | 0.076 | 0.330 | 0.003 | 0.013 | |
| b | 1.02 | 1.20 | 0.040 | 0.047 | |
| С | 0.22 | 0.33 | 0.009 | 0.013 | |
| D | 8.13 | 8.51 | 0.320 | 0.335 | |
| D1 | 3.90 | 4.10 | 0.154 | 0.161 | |
| E | 9.80 | 10.30 | 0.386 | 0.406 | |
| E1 | 6.20 | 6.50 | 0.244 | 0.256 | |
| е | 5.00 | 5.20 | 0.197 | 0.205 | |
| L | 1.02 | 1.53 | 0.040 | 0.060 | |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α | 2.30 | 0.091 |
| В | 1.30 | 0.051 |
| С | 6.90 | 0.272 |
| D | 11.50 | 0.453 |
| E | 2.60 | 0.102 |
| F | 9.20 | 0.362 |

MARKING DIAGRAM



P/N = Marking Code

G = Green Compound

YW = Date Code
F = Factory Code



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